

Single N-channel MOSFET

ELM13406CA-S

■General description

ELM13406CA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=30V$
- $I_d=3.6A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 65m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 105m\Omega$ ($V_{gs}=4.5V$)

■Maximum absolute ratings

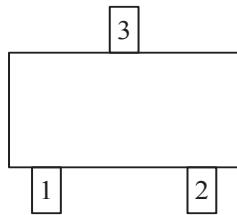
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current Ta=25°C	I_d	3.6	A	1
Ta=70°C	I_d	2.9		
Pulsed drain current	I_{dm}	15	A	2
Power dissipation Ta=25°C	P_d	1.4	W	1
Ta=70°C	P_d	0.9		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter	Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	70	90	°C/W	1
Maximum junction-to-ambient		100	125	°C/W	
Maximum junction-to-lead	$R_{\theta jl}$	63	80	°C/W	3

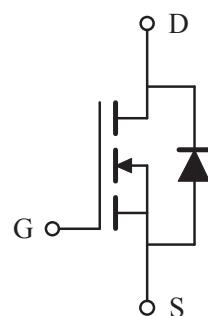
■Pin configuration

SOT-23(TOP VIEW)



Pin No.	Pin name
1	GATE
2	SOURCE
3	DRAIN

■Circuit



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■Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
STATIC PARAMETERS							
Drain-source breakdown voltage	BV_{dss}	$I_d=250\mu A$, $V_{gs}=0V$		30			V
Zero gate voltage drain current	Id_{ss}	$V_{ds}=24V$, $V_{gs}=0V$			1		μA
			$T_j=55^\circ C$			5	
Gate-body leakage current	I_{gss}	$V_{ds}=0V$, $V_{gs}=\pm 20V$				100	nA
Gate threshold voltage	$V_{gs(th)}$	$V_{ds}=V_{gs}$, $I_d=250\mu A$		1.0	1.9	3.0	V
On state drain current	$I_{d(on)}$	$V_{gs}=10V$, $V_{ds}=5V$		15			A
Static drain-source on-resistance	$R_{ds(on)}$	$V_{gs}=10V$, $I_d=3.6A$			50	65	$m\Omega$
			$T_j=125^\circ C$		74	100	
		$V_{gs}=4.5V$, $I_d=2.8A$			75	105	$m\Omega$
Forward transconductance	G_{fs}	$V_{ds}=5V$, $I_d=3.6A$			7		S
Diode forward voltage	V_{sd}	$I_s=1A$			0.79	1.00	V
Max. body-diode continuous current	I_s					2.5	A
DYNAMIC PARAMETERS							
Input capacitance	C_{iss}	$V_{gs}=0V$, $V_{ds}=15V$, $f=1MHz$			288	375	pF
Output capacitance	C_{oss}				57		pF
Reverse transfer capacitance	C_{rss}				39		pF
Gate resistance	R_g	$V_{gs}=0V$, $V_{ds}=0V$, $f=1MHz$			3	6	Ω
SWITCHING PARAMETERS							
Total gate charge (10V)	Q_g	$V_{gs}=10V$, $V_{ds}=15V$, $I_d=3.6A$			6.5	8.5	nC
Total gate charge (4.5V)	Q_g				3.1	4.0	nC
Gate-source charge	Q_{gs}				1.2		nC
Gate-drain charge	Q_{gd}				1.6		nC
Turn-on delay time	$t_{d(on)}$	$V_{gs}=10V$, $V_{ds}=15V$			4.6		ns
Turn-on rise time	t_r				1.9		ns
Turn-off delay time	$t_{d(off)}$		$R_l=2.2\Omega$, $R_{gen}=3\Omega$		20.1		ns
Turn-off fall time	t_f				2.6		ns
Body diode reverse recovery time	t_{rr}		$I_f=3.6A$, $dl/dt=100A/\mu s$		10.2	14.0	ns
Body diode reverse recovery charge	Q_{rr}	$I_f=3.6A$, $dl/dt=100A/\mu s$			3.5		nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design. The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.



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■ Typical electrical and thermal characteristics

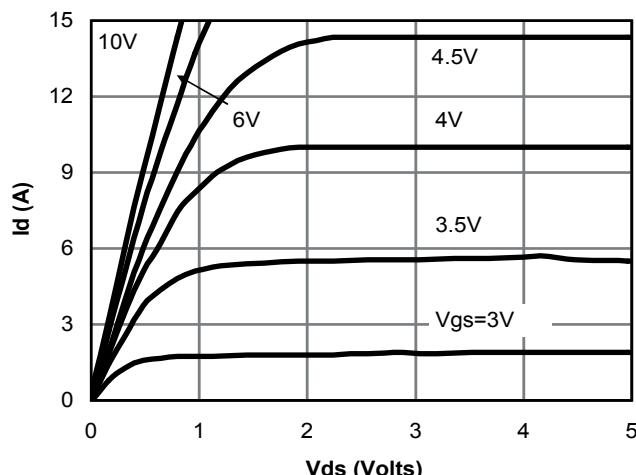


Fig 1: On-Region Characteristics

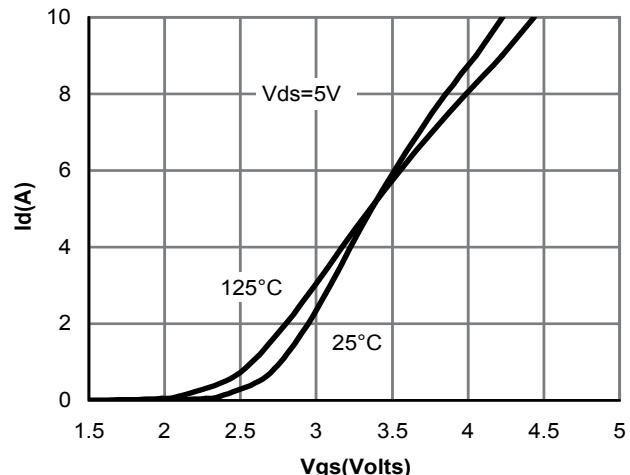


Figure 2: Transfer Characteristics

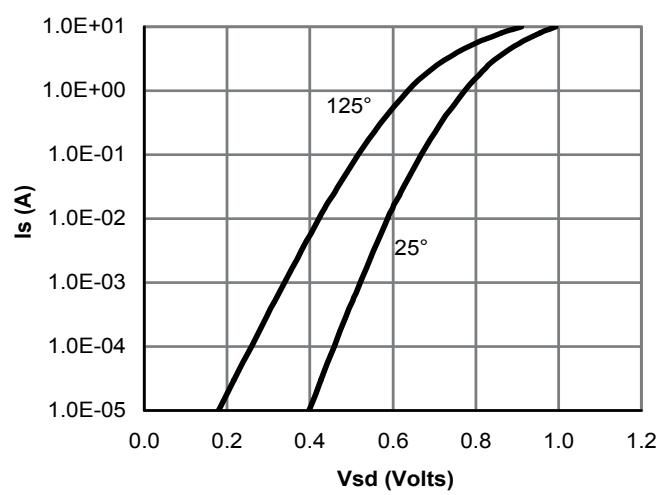
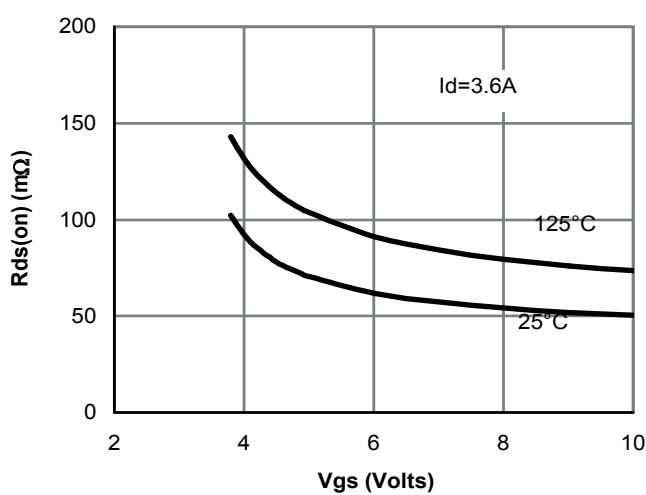
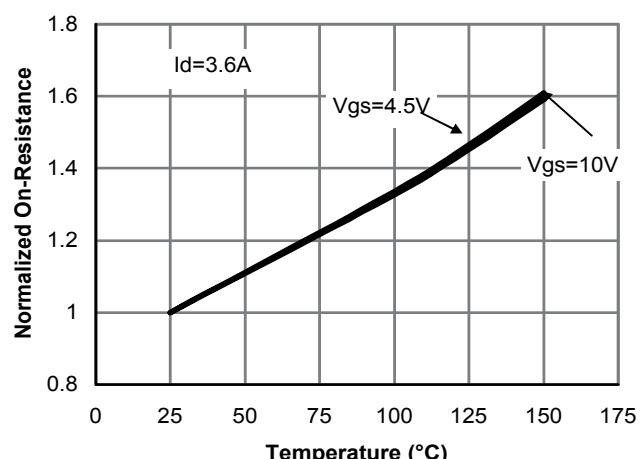
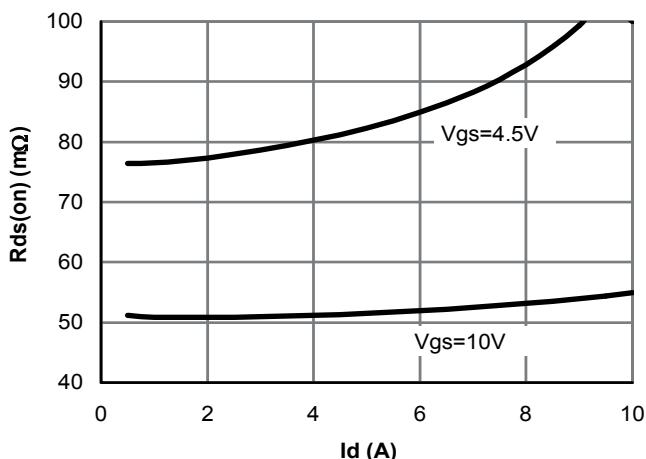


Figure 6: Body-Diode Characteristics

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